



Material Content Data Sheet



Sales Product Name		1EDI2001AS		Issued		3. July 2019		
MA#		MA001361976						
Package		PG-DSO-36-63		Weight*		695.11 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip_1	inorganic material	silicon	7440-21-3	3.979	0.57	0.57	5725	5725
chip_2	inorganic material	silicon	7440-21-3	4.454	0.64	0.64	6407	6407
leadframe	inorganic material	phosphorus	7723-14-0	0.083	0.01		120	
	non noble metal	zinc	7440-66-6	0.334	0.05		480	
	non noble metal	iron	7439-89-6	6.680	0.96		9610	
wire	non noble metal	copper	7440-50-8	271.228	39.02	40.04	390198	400408
	noble metal	gold	7440-57-5	1.103	0.16	0.16	1587	1587
	encapsulation	organic material	carbon black	1333-86-4	1.192	0.17		1715
encapsulation	plastics	epoxy resin	-	46.493	6.69		66887	
	inorganic material	silicondioxide	60676-86-0	349.692	50.32	57.18	503077	571679
	leadfinish	noble metal	palladium	7440-05-3	0.001	0.00		2
plating	noble metal	silver	7440-22-4	0.001	0.00		2	
	noble metal	gold	7440-57-5	0.002	0.00		3	
	non noble metal	nickel	7440-02-0	2.350	0.34	0.34	3381	3388
	noble metal	silver	7440-22-4	0.002	0.00		3	
plating	noble metal	palladium	7440-05-3	0.003	0.00		4	
	noble metal	gold	7440-57-5	0.004	0.00		6	
	non noble metal	nickel	7440-02-0	4.335	0.62	0.62	6237	6250
glue	plastics	epoxy resin	-	0.792	0.11		1139	
	noble metal	silver	7440-22-4	2.375	0.34	0.45	3417	4556
*deviation	< 10%				Sum in total:		100.00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com